

LNPTM LUBRICOMPTM COMPOUND JX91198

PDX-J-91198 REGION AMERICAS

DESCRIPTION

LNP LUBRICOMP JX91198 compound is based on Polyethersulfone (PES) resin containing 10% Carbon Fiber, 10% PTFE and proprietary lubricant. Added features of this grade include: Wear Resistant.

GENERAL INFORMATION	
Features	Wear resistant, High temperature resistance
Fillers	Carbon Fiber, PTFE
Polymer Types	Polyethersulfone (PESU)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Building Component
Consumer	Sport/Leisure, Personal Accessory, Home Appliances, Commercial Appliance
Electrical and Electronics	Mobile Phone - Computer - Tablets
Industrial	Electrical

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL (1)			
Tensile Stress, break	116	MPa	ASTM D638
Tensile Strain, break	1.9	%	ASTM D638
Tensile Modulus, 50 mm/min	10130	MPa	ASTM D638
Flexural Stress	169	MPa	ASTM D790
Flexural Modulus	8820	MPa	ASTM D790
Tensile Stress, break	112	MPa	ISO 527
Tensile Strain, break	1.8	%	ISO 527
Tensile Modulus, 1 mm/min	9200	MPa	ISO 527
Flexural Stress	161	MPa	ISO 178
Flexural Modulus	9230	MPa	ISO 178
IMPACT (1)			
Izod Impact, unnotched, 23°C	331	J/m	ASTM D4812
Izod Impact, notched, 23°C	42	J/m	ASTM D256
Instrumented Dart Impact Energy @ peak, 23°C	4	J	ASTM D3763
Multiaxial Impact	2	J	ISO 6603
Izod Impact, unnotched 80*10*4 +23°C	26	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	7	kJ/m²	ISO 180/1A
THERMAL (1)			
HDT, 1.82 MPa, 3.2mm, unannealed	211	°C	ASTM D648



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	228	°C	ISO 75/Af
PHYSICAL (1)			
Density	1.5	g/cm³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.41	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.2	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.4	%	ASTM D955
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.17	%	ISO 294
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.41	%	ISO 294
Wear Factor Washer	4	10^-10 in^5-min/ft-lb-hr	ASTM D3702 Modified: Manual
Dynamic COF	0.43	-	ASTM D3702 Modified: Manual
Static COF	0.34	-	ASTM D3702 Modified: Manual
Density	1.5	g/cm³	ISO 1183
Moisture Absorption (23°C / 50% RH)	0.53	%	ISO 62
INJECTION MOLDING (3)			
Drying Temperature	120 – 150	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.05	%	
Melt Temperature	355 – 370	°C	
Front - Zone 3 Temperature	370 – 380	°C	
Middle - Zone 2 Temperature	360 – 370	°C	
Rear - Zone 1 Temperature	345 – 355	°C	
Mold Temperature	140 – 150	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	60 – 100	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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